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	Filing Date		2002-01-28	
	First Named Inventor	Todd S. Smith		
	Art Unit	3733		
	Examiner Name	UNK		
Attorney Docket Number		265280-68002		

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/A,R./	1	PESCHANSKAYA, N. et al., "Deformation of Poly(methyl methacrylate) after Exposure to Radiation and Magnetic Fields," Physics of the Solid State, 2002, pgs. 1791-1794, Vol. 44, No. 9, Russia	<input type="checkbox"/>
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